

TOSHIBA MOS MEMORY PRODUCTS

1,048,576 WORD × 1 BIT DYNAMIC RAM

SILICON GATE CMOS

TC511000P/J/Z-85, TC511000P/J/Z-10
TC511000P/J/Z-12

DESCRIPTION

The TC511000P/J/Z is the new generation dynamic RAM organized 1,048,576 words by 1 bit. The TC511000P/J/Z utilizes TOSHIBA's CMOS Silicon gate process technology as well as advanced circuit techniques to provide wide operating margins, both internally and to the system user. Multiplexed address inputs permit the TC511000P/J/Z to be packaged in a standard 18 pin plastic DIP, 26/20 pin plastic SOJ and 20/19 pin plastic

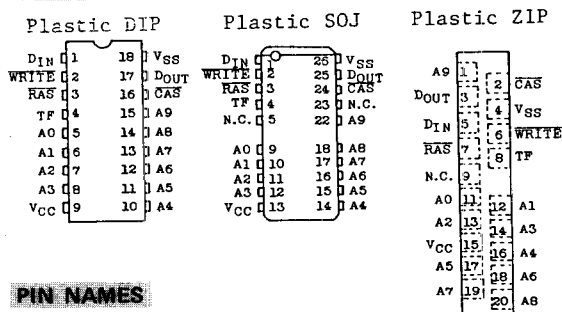
FEATURES

- 1,048,576 word by 1 bit organization
- Fast access time and cycle time

		TC511000P/J/Z-85-10-12		
t _{RAC}	RAS Access Time	85 ns	100 ns	120 ns
t _{AA}	Column Address Access Time	45 ns	50 ns	60 ns
t _{CAC}	CAS Access Time	25 ns	25 ns	30 ns
t _{RC}	Cycle Time	165 ns	190 ns	220 ns
t _{PC}	Fast Page Mode Cycle Time	50 ns	55 ns	70 ns

- Single power supply of 5V ± 10% with a built-in V_{BB} generator

PIN CONNECTION (TOP VIEW)



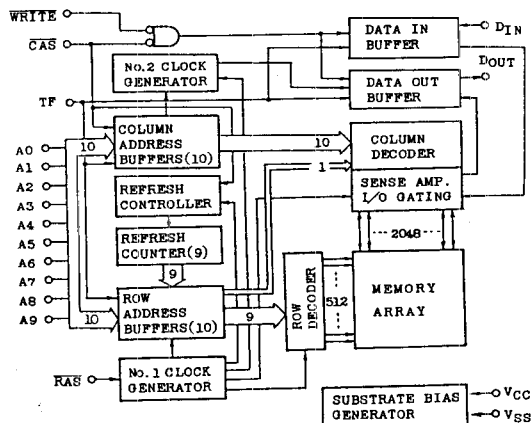
PIN NAMES

A0 ~ A9	Address Inputs
RAS	Row Address Strobe
D _{IN}	Data In
D _{OUT}	Data Out
CAS	Column Address Strobe
WRITE	Read/Write Input
V _{CC}	Power (+5V)
V _{SS}	Ground
TF	Test Function
N.C.	No Connection

ZIP. The package size provides high system bit densities and is compatible with widely available automated testing and insertion equipment. System oriented features include single power supply of 5V ± 10% tolerance, direct interfacing capability with high performance logic families such as Schottky TTL. "Test Mode" function is implemented from Revision C.

- Low Power
385mW MAX. Operating (TC511000P/J/Z-85)
330mW MAX. Operating (TC511000P/J/Z-10)
275mW MAX. Operating (TC511000P/J/Z-12)
5.5mW MAX. Standby
- Output unlatched at cycle end allows two-dimensional chip selection
- Common I/O capability using "EARLY WRITE" operation
- Read-Modify-Write, $\overline{\text{CAS}}$ before $\overline{\text{RAS}}$ refresh, $\overline{\text{RAS}}$ -only refresh, Hidden refresh, Fast Page Mode and Test Mode capability
- All inputs and output TTL compatible
- 512 refresh cycles/8 ms
- Package Plastic DIP : TC511000P
Plastic SOJ : TC511000J
Plastic ZIP : TC511000Z

BLOCK DIAGRAM



TC511000P/J/Z-85, TC511000P/J/Z-10 TC511000P/J/Z-12

ABSOLUTE MAXIMUM RATINGS

ITEM	SYMBOL	RATING	UNITS	NOTES
Input Voltage	V_{IN}	$-1 \sim 7$	V	1
Test Function Input Voltage	$V_{IN(TF)}$	$-1 \sim 10.5$	V	1
Output Voltage	V_{OUT}	$-1 \sim 7$	V	1
Power Supply Voltage	V_{CC}	$-1 \sim 7$	V	1
Operating Temperature	T_{OPR}	$0 \sim 70$	$^{\circ}\text{C}$	1
Storage Temperature	T_{STG}	$-55 \sim 150$	$^{\circ}\text{C}$	1
Soldering Temperature* Time	T_{SOLDER}	$260 \cdot 10$	$^{\circ}\text{C} \cdot \text{sec}$	1
Power Dissipation	P_D	600	mW	1
Short Circuit Output Current	I_{OUT}	50	mA	1

RECOMMENDED DC OPERATING CONDITIONS (Ta = 0 ~ 70°C)

SYMBOL	PARAMETER	MIN.	TYP.	MAX.	UNIT	NOTES
V_{CC}	Supply Voltage	4.5	5.0	5.5	V	2
V_{IH}	Input High Voltage	2.4	--	6.5	V	2
V_{IL}	Input Low Voltage	-1.0	--	0.8	V	2
$V_{IH(TF)}$	Test Enable Input High Voltage	$V_{CC} + 4.5$	--	10.5	V	2
$V_{IL(TF)}$	Test Disable Input Low Voltage	-1.0	--	$V_{CC} + 1.0$	V	2

DC ELECTRICAL CHARACTERISTICS (V_{CC} = 5V ± 10%, Ta = 0 ~ 70°C)

SYMBOL	PARAMETER		MIN.	MAX.	UNITS	NOTES
I _{CC1}	OPERATING CURRENT Average Power Supply Operating Current (RAS, CAS, Address Cycling: t _{RC} = t _{RC} MIN.)	TC511000P/J/Z-85	—	70	mA	3, 4
		TC511000P/J/Z-10	—	60		
		TC511000P/J/Z-12	—	50		
I _{CC2}	STANDBY CURRENT Power Supply Standby Current (RAS = CAS = V _{IH})		—	2	mA	
I _{CC3}	RAS ONLY REFRESH CURRENT Average Power Supply Current, RAS Only Mode (RAS Cycling, CAS = V _{IH} : t _{RC} = t _{RC} MIN.)	TC511000P/J/Z-85	—	70	mA	3
		TC511000P/J/Z-10	—	60		
		TC511000P/J/Z-12	—	50		
I _{CC4}	FAST PAGE MODE CURRENT Average Power Supply Current, Fast Page Mode (RAS = V _{IL} , CAS, Address Cycling: t _{PC} = t _{PC} MIN.)	TC511000P/J/Z-85	—	50	mA	3, 4
		TC511000P/J/Z-10	—	40		
		TC511000P/J/Z-12	—	30		
I _{CC5}	STANDBY CURRENT Power Supply Standby Current (RAS = CAS = V _{CC} -0.2V)		—	1	mA	
I _{CC6}	CAS BEFORE RAS REFRESH CURRENT Average Power Supply Current, CAS Before RAS Mode (RAS, CAS Cycling: t _{RC} = t _{RC} MIN.)	TC511000P/J/Z-85	—	70	mA	3
		TC511000P/J/Z-10	—	60		
		TC511000P/J/Z-12	—	50		
I _{I(L)}	INPUT LEAKAGE CURRENT (any input except TF) Input Leakage Current, any input (0V ≤ V _{IN} ≤ 6.5V, All Other Pins Not Under Test = 0V)		−10	10	μA	
I _{ITF(L)}	INPUT LEAKAGE CURRENT (only TF) (0V ≤ V _{IN} (TF) ≤ V _{CC} + 0.5V, All Other Pins Not Under Test = 0V)		−10	10	μA	
I _{O(L)}	OUTPUT LEAKAGE CURRENT (D _{OUT} is disabled, 0V ≤ V _{OUT} ≤ 5.5V)		−10	10	μA	
I _{TF}	TEST FUNCTION INPUT CURRENT (V _{CC} + 4.5V ≤ V _{IN} (TF) ≤ 10.5V)		—	1	mA	
V _{OH}	OUTPUT LEVEL Output "H" Level Voltage (I _{OUT} = −5 mA)		2.4	—	V	
V _{OL}	OUTPUT LEVEL Output "L" Level Voltage (I _{OUT} = 4.2 mA)		—	0.4	V	

TC511000P/J/Z-85, TC511000P/J/Z-10 TC511000P/J/Z-12

ELECTRICAL CHARACTERISTICS AND RECOMMENDED AC OPERATING CONDITIONS

($V_{CC} = 5V \pm 10\%$, $T_a = 0 \sim 70^\circ C$) (Notes 5, 6, 7)

SYMBOL	PARAMETER	TC511000P/ J/Z-85		TC511000P/ J/Z-10		TC511000P/ J/Z-12		UNITS	NOTES
		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.		
t_{RC}	Random Read or Write Cycle Time	165	—	190	—	220	—	ns	
t_{RWC}	Read-Write Cycle Time	190	—	220	—	255	—	ns	
t_{PC}	Fast Page Mode Cycle Time	50	—	55	—	70	—	ns	
t_{PRWC}	Fast Page Mode Read-Write Cycle Time	75	—	85	—	105	—	ns	
t_{RAC}	Access Time from $\overline{RAS}$	—	85	—	100	—	120	ns	8, 13
t_{CAC}	Access Time from $\overline{CAS}$	—	25	—	25	—	30	ns	8, 13
t_{AA}	Access Time from Column Address	—	45	—	50	—	60	ns	8, 14
t_{CPA}	Access Time from $\overline{CAS}$ Precharge	—	45	—	50	—	65	ns	8
t_{CLZ}	$\overline{CAS}$ to Output in Low-Z	5	—	5	—	5	—	ns	8
t_{OFF}	Output Buffer Turn-off Delay	0	30	0	30	0	35	ns	9
t_T	Transition Time (Rise and Fall)	3	50	3	50	3	50	ns	7
t_{RP}	$\overline{RAS}$ Precharge Time	70	—	80	—	90	—	ns	
t_{RAS}	$\overline{RAS}$ Pulse Width	85	10,000	100	10,000	120	10,000	ns	
t_{RASP}	$\overline{RAS}$ Pulse Width (Fast Page Mode)	85	100,000	100	100,000	120	100,000	ns	
t_{RSH}	$\overline{RAS}$ Hold Time	25	—	25	—	30	—	ns	
t_{CSH}	$\overline{CAS}$ Hold Time	85	—	100	—	120	—	ns	
t_{CAS}	$\overline{CAS}$ Pulse Width	25	10,000	25	10,000	30	10,000	ns	
t_{RCD}	$\overline{RAS}$ to $\overline{CAS}$ Delay Time	25	60	25	75	25	90	ns	13
t_{RAD}	$\overline{RAS}$ to Column Address Delay Time	20	40	20	50	20	60	ns	14
t_{CRP}	$\overline{CAS}$ to $\overline{RAS}$ Precharge Time	10	—	10	—	10	—	ns	
t_{CP}	$\overline{CAS}$ Precharge Time (Fast Page Mode)	10	—	10	—	15	—	ns	
t_{ASR}	Row Address Set-Up Time	0	—	0	—	0	—	ns	
t_{RAH}	Row Address Hold Time	15	—	15	—	15	—	ns	
t_{ASC}	Column Address Set-Up Time	0	—	0	—	0	—	ns	
t_{CAH}	Column Address Hold Time	20	—	20	—	25	—	ns	
t_{AR}	Column Address Hold Time referenced to $\overline{RAS}$	65	—	75	—	90	—	ns	
t_{RAL}	Column Address to $\overline{RAS}$ Lead Time	45	—	50	—	60	—	ns	
t_{RCS}	Read Command Set-Up Time	0	—	0	—	0	—	ns	
t_{RCH}	Read Command Hold Time	0	—	0	—	0	—	ns	10
t_{RRH}	Read Command Hold Time referenced to $\overline{RAS}$	0	—	0	—	0	—	ns	10
t_{WCH}	Write Command Hold Time	20	—	20	—	25	—	ns	
t_{WCR}	Write Command Hold Time referenced to $\overline{RAS}$	65	—	75	—	90	—	ns	
t_{WP}	Write Command Pulse Width	20	—	20	—	25	—	ns	
t_{RWL}	Write Command to $\overline{RAS}$ Lead Time	20	—	25	—	30	—	ns	
t_{CWL}	Write Command to $\overline{CAS}$ Lead Time	20	—	25	—	30	—	ns	
t_{DS}	Data Set-Up Time	0	—	0	—	0	—	ns	11
t_{DH}	Data Hold Time	20	—	20	—	25	—	ns	11
t_{DHR}	Data Hold Time referenced to $\overline{RAS}$	65	—	75	—	90	—	ns	
t_{REF}	Refresh Period	—	8	—	8	—	8	ms	

TC511000P/J/Z-85, TC511000P/J/Z-10 TC511000P/J/Z-12

ELECTRICAL CHARACTERISTICS AND RECOMMENDED AC OPERATING CONDITIONS (Continued)

SYMBOL	PARAMETER	TC511000P/ J/Z-85		TC511000P/ J/Z-10		TC511000P/ J/Z-12		UNIT	NOTES
		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.		
t _{WCS}	Write Command Set-Up Time	0	—	0	—	0	—	ns	12
t _{CWD}	CAS to WRITE Delay Time	25	—	25	—	30	—	ns	12
t _{RWD}	RAS to WRITE Delay Time	85	—	100	—	120	—	ns	12
t _{AWD}	Column Address to WRITE Delay Time	45	—	50	—	60	—	ns	12
t _{CSR}	CAS Set-Up Time (CAS before RAS Cycle)	10	—	10	—	10	—	ns	
t _{CHR}	CAS Hold Time (CAS before RAS Cycle)	30	—	30	—	30	—	ns	
t _{RPC}	RAS to CAS Precharge Time	0	—	0	—	0	—	ns	
t _{CPT}	CAS Precharge Time (CAS before RAS Counter Test Cycle)	50	—	50	—	60	—	ns	
t _{CPN}	CAS Precharge Time	15	—	15	—	20	—	ns	
t _{TES}	Test Mode Enable Set-Up Time referenced to RAS	0	—	0	—	0	—	ns	
t _{TEHR}	Test Mode Enable Hold Time referenced to RAS	0	—	0	—	0	—	ns	
t _{TEHC}	Test Mode Enable Hold Time referenced to CAS	0	—	0	—	0	—	ns	

CAPACITANCE ($V_{CC} = 5V \pm 10\%$, $f = 1\text{ MHz}$, $T_a = 0 \sim 70^\circ\text{C}$)

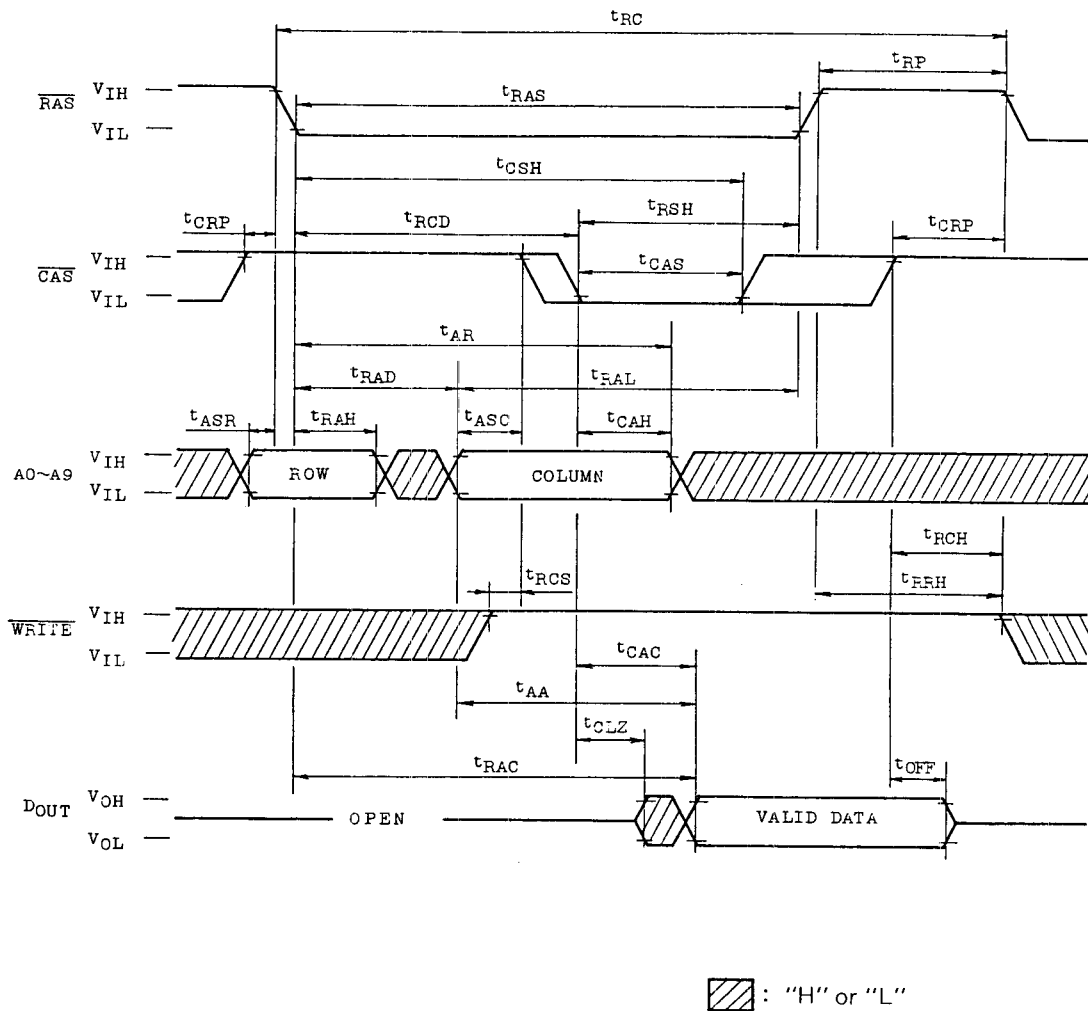
SYMBOL	PARAMETER	MIN.	MAX.	UNIT
C_{I1}	Input Capacitance ($A0 \sim A9, D_{IN}$)	—	5	pF
C_{I2}	Input Capacitance ($\overline{RAS}$, $\overline{CAS}$, $\overline{WRITE}$, TF)	—	7	pF
C_O	Output Capacitance (D_{OUT})	—	7	pF

NOTES:

- Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device.
- All Voltages are referenced to V_{SS} .
- I_{CC1} , I_{CC3} , I_{CC4} , I_{CC6} depend on cycle rate.
- I_{CC1} , I_{CC4} depend on output loading. Specified values are obtained with the output open.
- An initial pause of $200\mu\text{s}$ is required after power-up followed by 8 $\overline{RAS}$ cycles before proper device operation is achieved. In case of using internal refresh counter, a minimum of 8 $\overline{CAS}$ before $\overline{RAS}$ initialization cycles instead of 8 $\overline{RAS}$ cycles are required.
- AC measurements assume $t_T = 5\text{ns}$.
- V_{IH} (min.) and V_{IL} (max.) are reference levels for measuring timing of input signals. Also, transition times are measured between V_{IH} and V_{IL} .
- Measured with a load equivalent to 2 TTL loads and 100pF .
- t_{OFF} (max.) defines the time at which the output achieves the open circuit condition and is not referenced to output voltage levels.
- Either t_{RCH} or t_{RRH} must be satisfied for a read cycle.
- These parameters are referenced to $\overline{CAS}$ leading edge in early write cycles and to $\overline{WRITE}$ leading edge in read-write cycles.
- t_{WCS} , t_{RWD} , t_{CWD} and t_{AWD} are not restrictive operating parameters. They are included the data sheet as electrical characteristics only. If $t_{WCS} \geq t_{WCS}(\text{min.})$, the cycle is an early write cycle and data out pin will remain open circuit (high impedance) through the entire cycle; If $t_{RWD} \geq t_{RWD}(\text{min.})$, $t_{CWD} \geq t_{CWD}(\text{min.})$ and $t_{AWD} \geq t_{AWD}(\text{min.})$, the cycle is a read-write cycle and data out will contain data read from the selected cell: If neither of the above sets of conditions is satisfied, the condition of the data out (at access time) is indeterminate.
- Operation within the $t_{RCD}(\text{max.})$ limit insures that $t_{RAC}(\text{max.})$ can be met. $t_{RCD}(\text{max.})$ is specified as a reference point only: If t_{RCD} is greater than the specified $t_{RCD}(\text{max.})$ limit, then access time is controlled by t_{CAC} .
- Operation within the $t_{RAD}(\text{max.})$ limit insures that $t_{RAC}(\text{max.})$ can be met. $t_{RAD}(\text{max.})$ is specified as a reference point only: If t_{RAD} is greater than the specified $t_{RAD}(\text{max.})$ limit, then access time is controlled by t_{AA} .

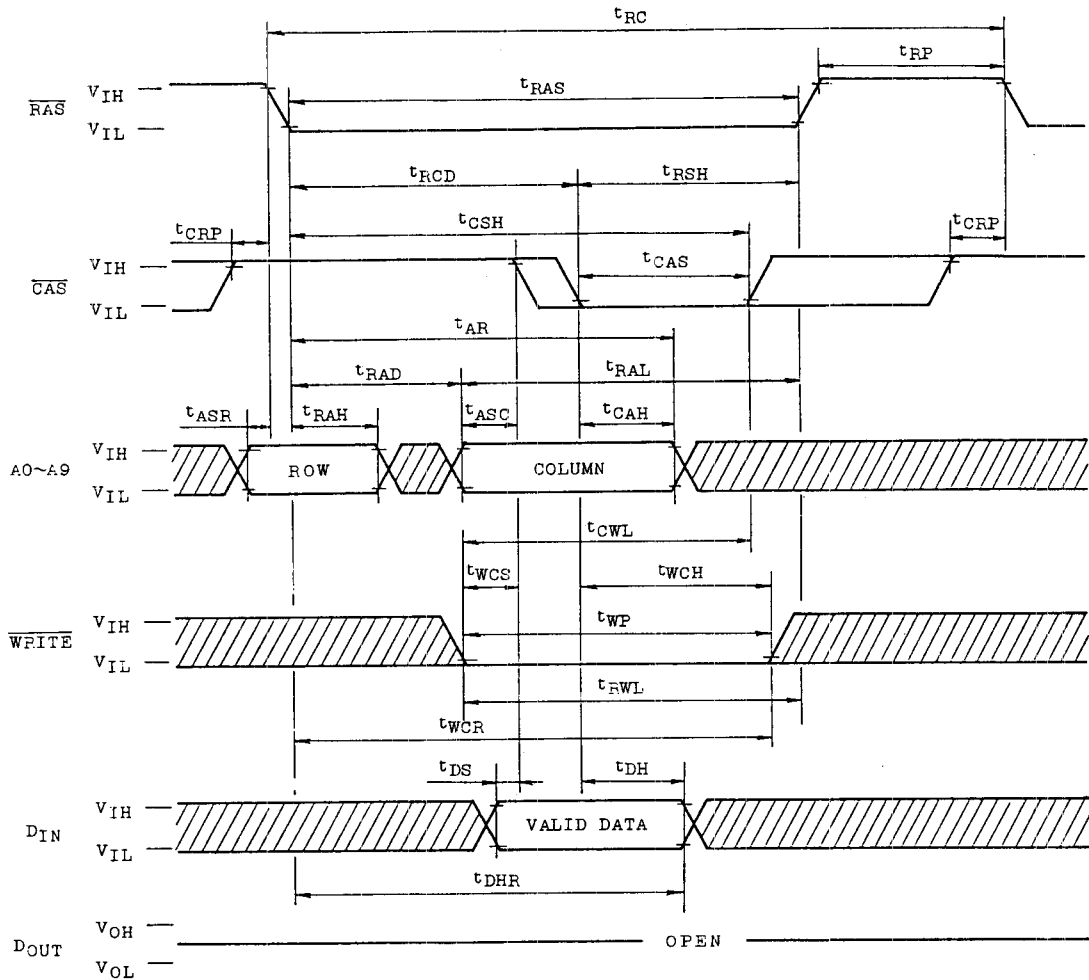
TIMING WAVEFORMS

• READ CYCLE



NOTE: "TF" pin should be connected to V_{IL} (TF) level or open, if "Test Mode" is not used.

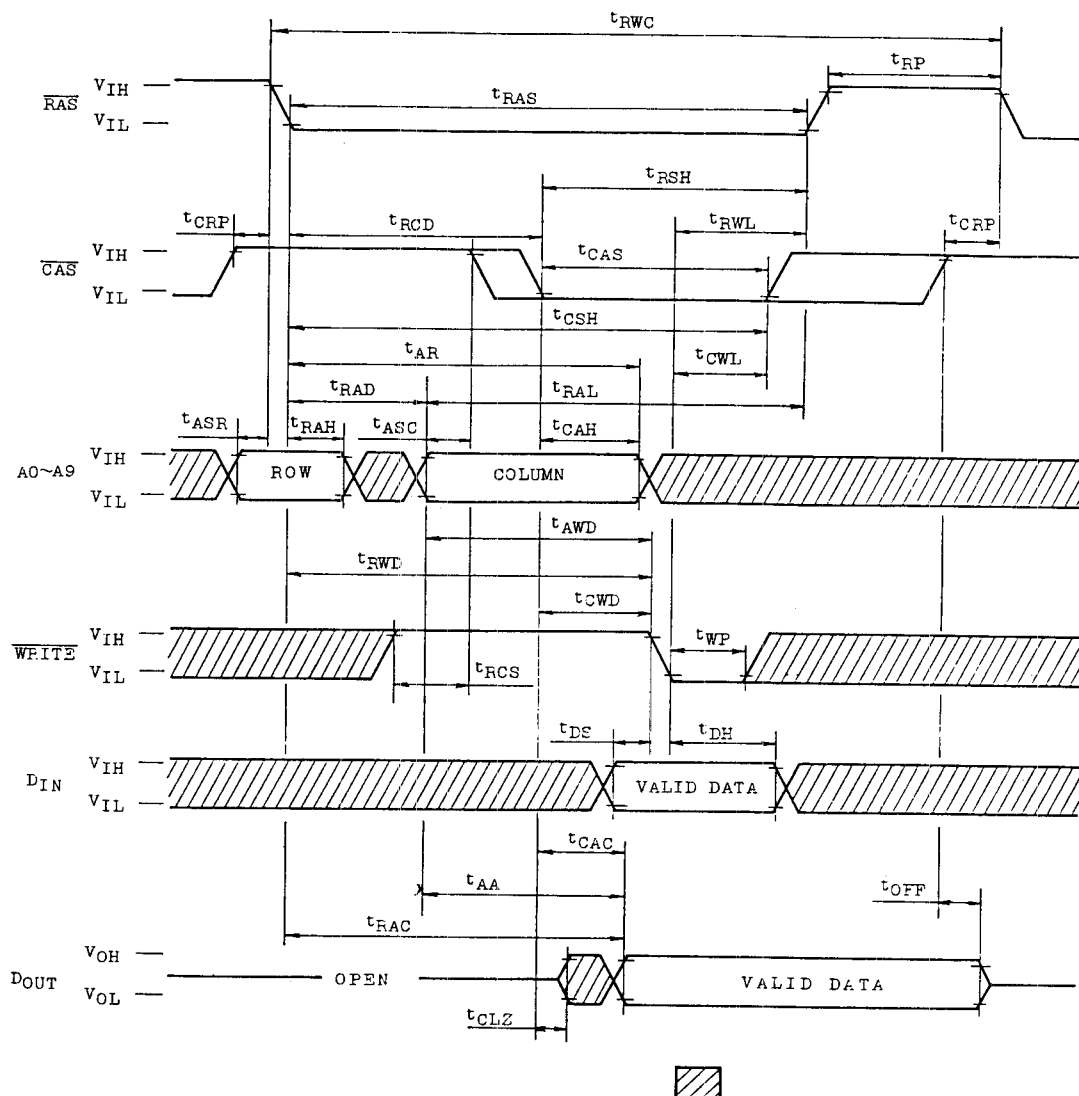
● WRITE CYCLE (EARLY WRITE)



NOTE: "TF" pin should be connected to V_{IL} (TF) level or open, if "Test Mode" is not used.

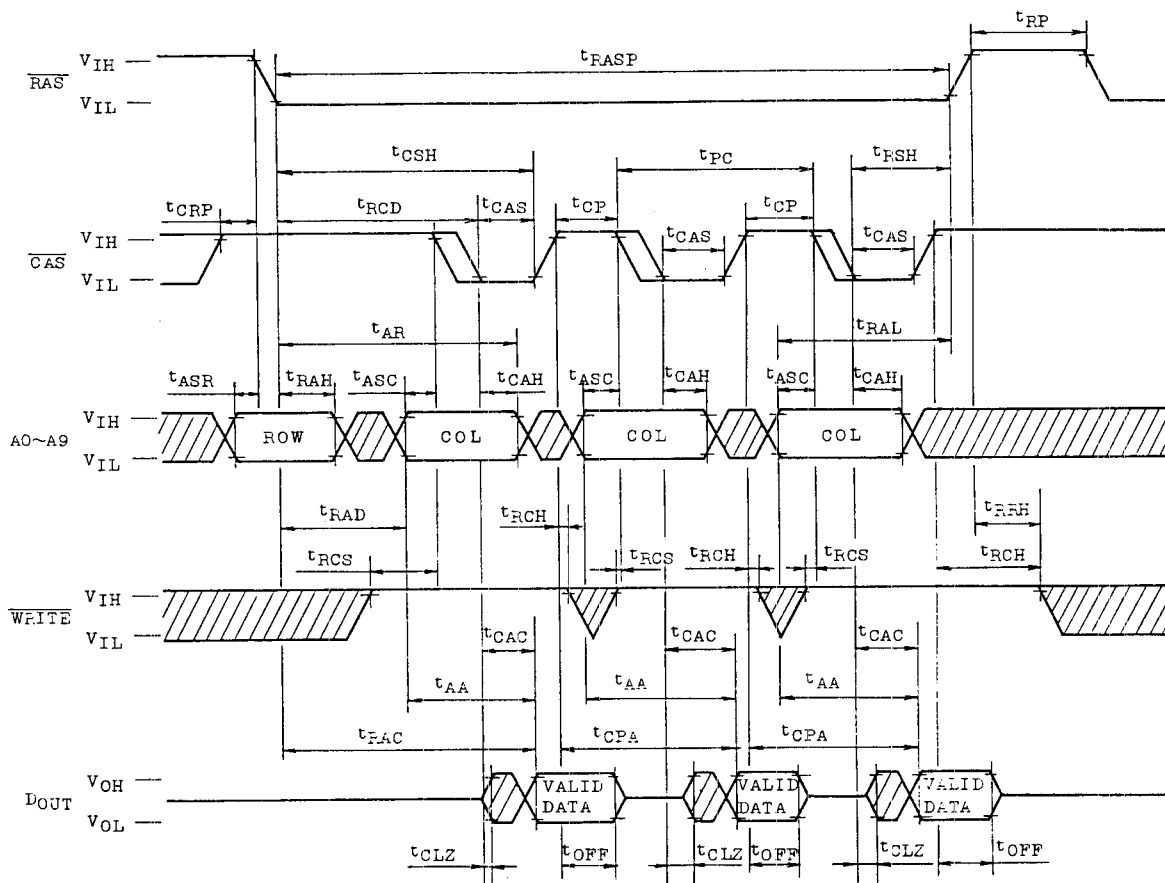
TC511000P/J/Z-85, TC511000P/J/Z-10 TC511000P/J/Z-12

• READ-WRITE CYCLE



NOTE: "TF" pin should be connected to V_{IL} (TF) level or open, if "Test Mode" is not used.

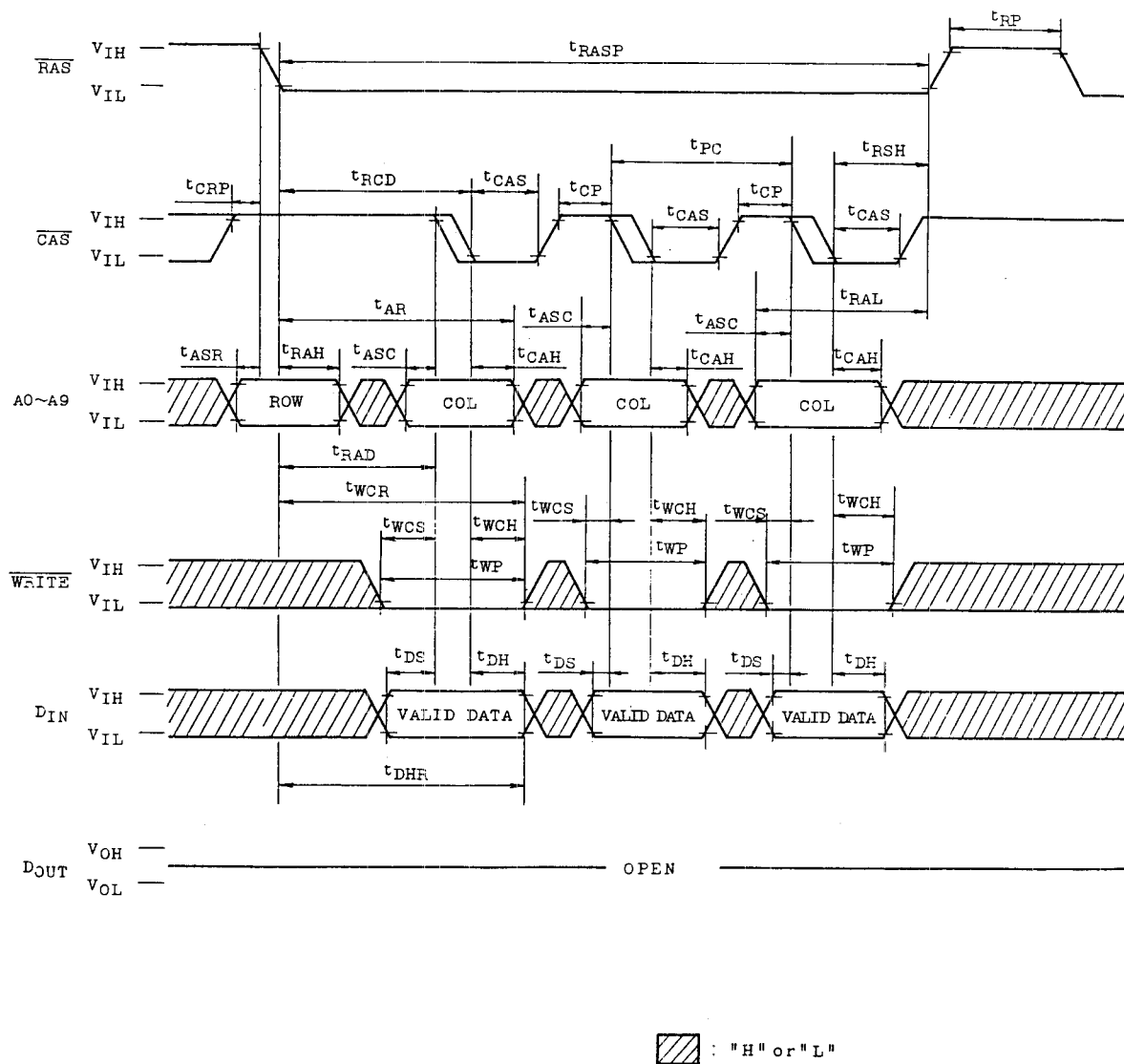
● FAST PAGE MODE READ CYCLE



▨ : "H" or "L"

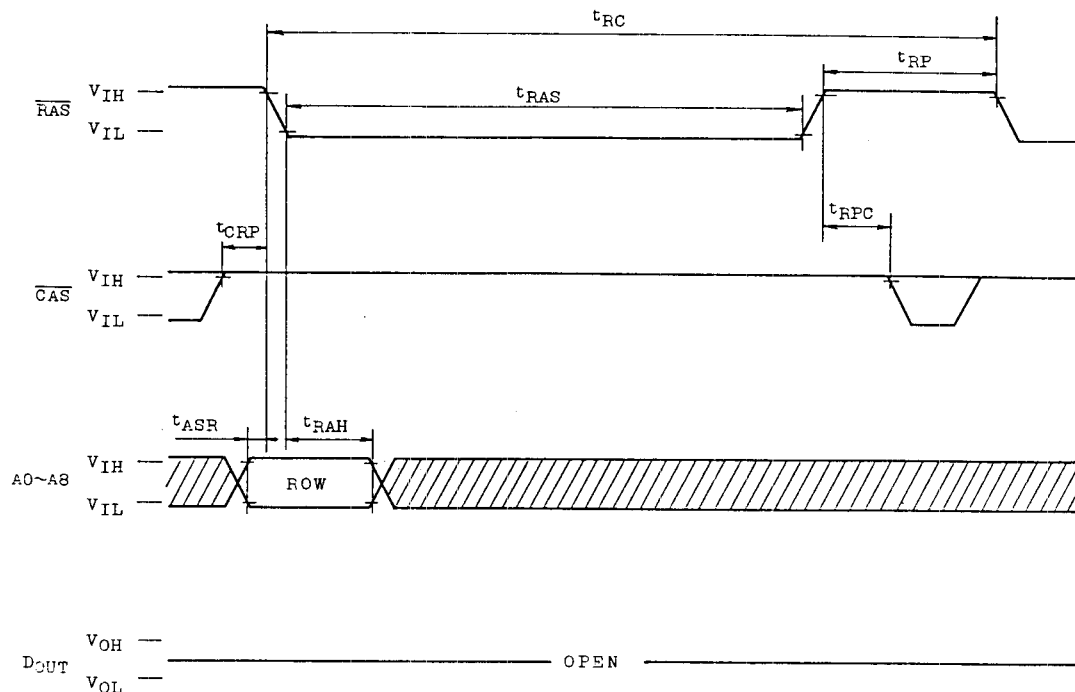
NOTE: "TF" pin should be connected to V_{IL} (TF) level or open, if "Test Mode" is not used.

• FAST PAGE MODE WRITE CYCLE (EARLY WRITE)



NOTE: "TF" pin should be connected to V_{IL} (TF) level or open, if "Test Mode" is not used.

● $\overline{\text{RAS}}$ ONLY REFRESH CYCLE

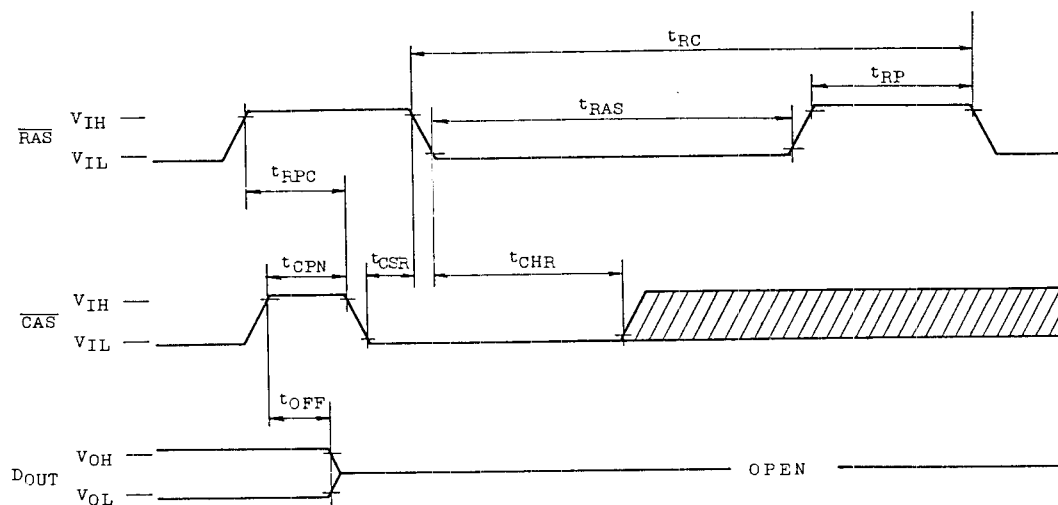


▨ : "H" or "L"

NOTE: $\overline{\text{WRITE}} = \text{"H" or "L"}$, $\text{A9} = \text{"H" or "L"}$

"TF" pin should be connected to V_{IL} (TF) level or open, if "Test Mode" is not used.

● $\overline{\text{CAS}}$ BEFORE $\overline{\text{RAS}}$ REFRESH CYCLE



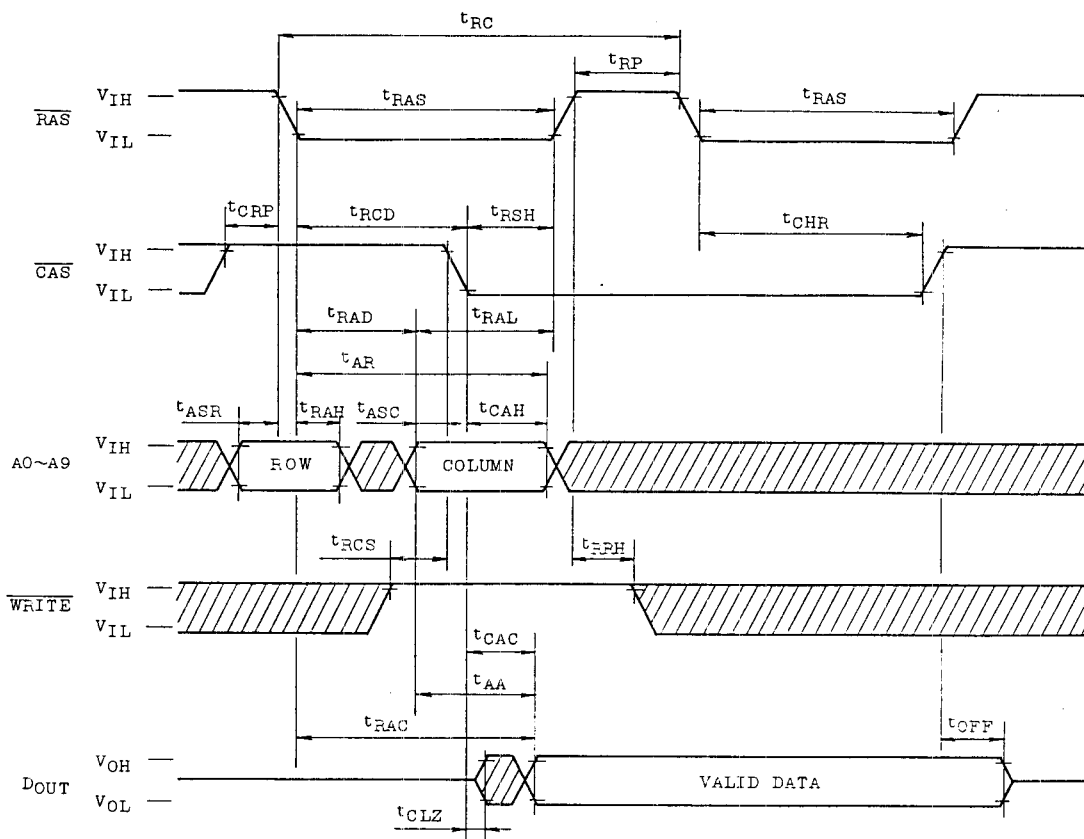
 : "H" or "L"

NOTE: $\overline{\text{WRITE}}$ = "H" or "L", $\text{A}_0 \sim \text{A}_9$ = "H" or "L"

"TF" pin should be connected to V_{IL} (TF) level or open, if "Test Mode" is not used.

TC511000P/J/Z-85, TC511000P/J/Z-10 **TC511000P/J/Z-12**

● HIDDEN REFRESH CYCLE (READ)

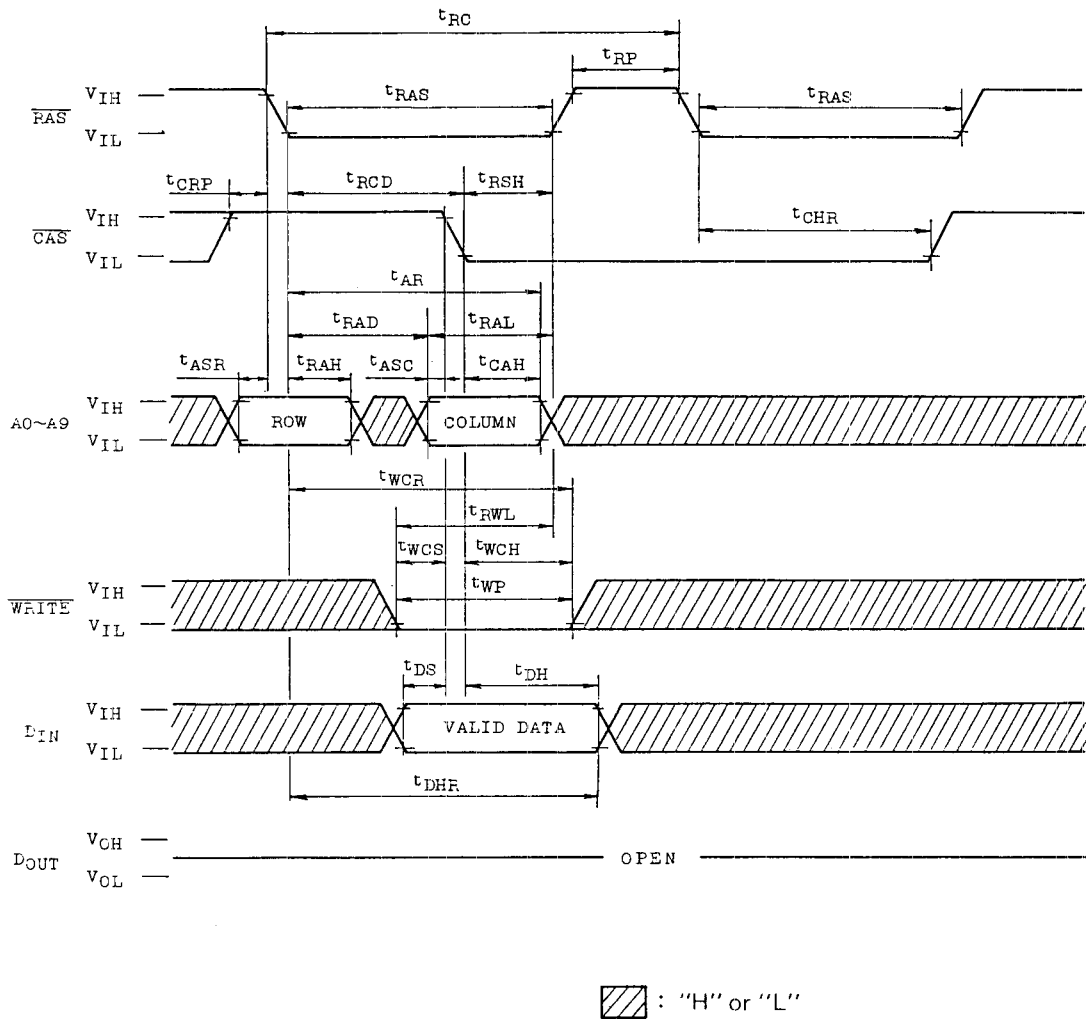


▨ : "H" or "L"

NOTE: "TF" pin should be connected to V_{IL} (TF) level or open, if "Test Mode" is not used.

TC511000P/J/Z-85, TC511000P/J/Z-10 TC511000P/J/Z-12

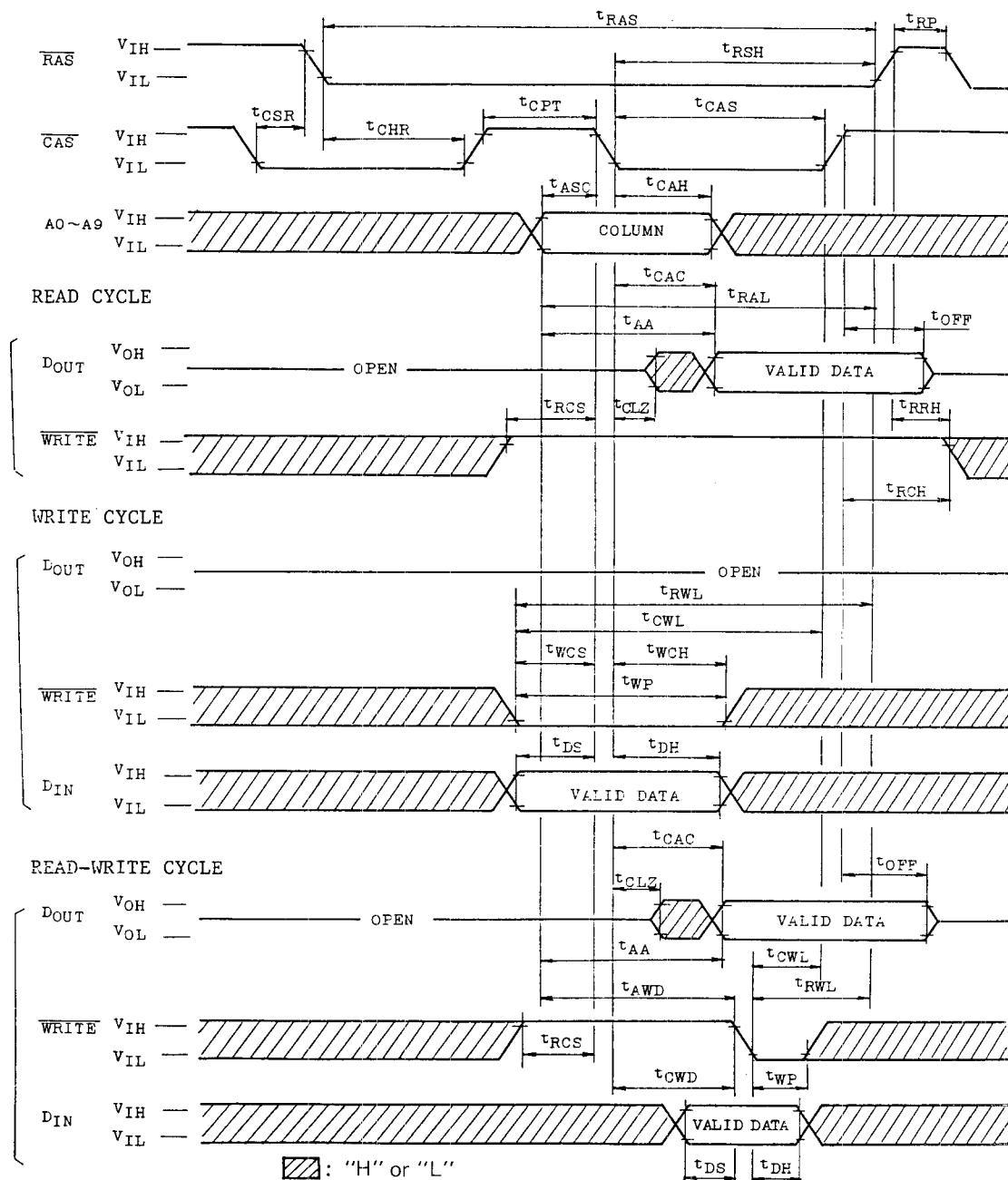
● HIDDEN REFRESH CYCLE (WRITE)



NOTE: "TF" pin should be connected to V_{IL} (TF) level or open, if "Test Mode" is not used.

TC511000P/J/Z-85, TC511000P/J/Z-10 **TC511000P/J/Z-12**

• CAS BEFORE RAS REFRESH COUNTER TEST CYCLE



NOTE: "TF" pin should be connected to V_{IL} (TF) level or open, if "Test Mode" is not used.

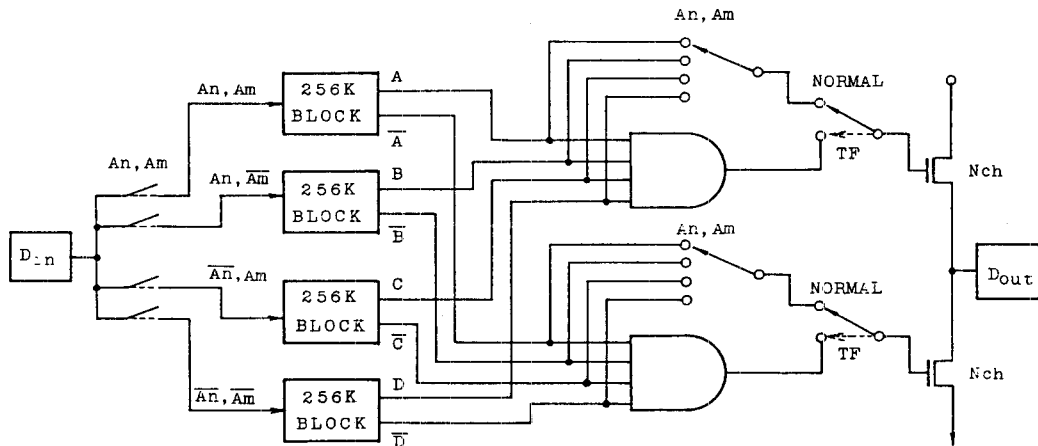
TEST MODE

The TC511000P/J/Z is the RAM organized 1,048,576 words by 1 bit, it is internally organized 262,144 words by 4 bits. In "Test Mode", data would be written into a number of sectors (4 sectors) in parallel and retrieved the same way. If upon reading, all bits are equal (all "H" or "L"), the data output pin indicates a same data as all bits. In this case, the data output pin indicates an expected data for good

parts, the data output pin indicates a complementary data for bad parts. And also, if any of the bits differed, the data output pin would indicate a high impedance state for bad parts. Fig. 1 shows the block diagram of TC511000P/J/Z including its truth table when "Test Mode" is used.

In test mode, 1MDRAM can be tested as if it were 256K DRAM by the following method.

Block Diagram in Test Mode



TF Pin = Super voltage; Test Mode
TF Pin = $V_{IL(TF)}$ level or High-Z; Normal

Truth Table in Test Mode Function

A	B	C	D	DOUT
0	0	0	0	0
1	1	1	1	1
otherwise				Hi-Z

Fig. 1

TC511000P/J/Z-85, TC511000P/J/Z-10 TC511000P/J/Z-12

"Test Mode" function is performed on any of the timing cycles including fast page mode when "TF" pin is held on "super voltage ($V_{CC} + 4.5V$ ($V_{CC} = 5V \pm 10\%$), max. voltage = 10.5V)" for the specified period (t_{TES} , t_{TEHR} and t_{TEHC} ; see Fig. 2). The address input of A9 is ignored in the "Test Mode".

On the other hand, normal operation requires the "TF" pin be connected to V_{IL} (TF) level, or left unconnected on the printed wiring board.

The "Test Mode" function reduces test times (1/4; in case of using N test pattern). This "Test Mode" function is implemented from Revision "C".

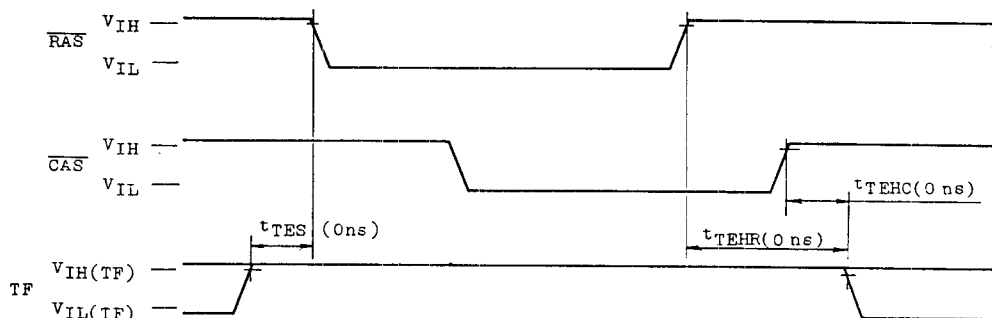
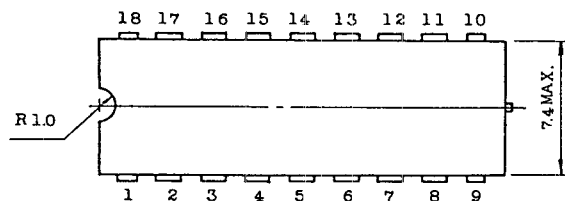


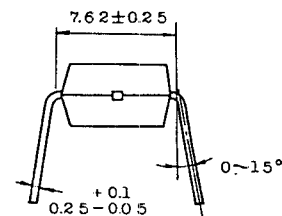
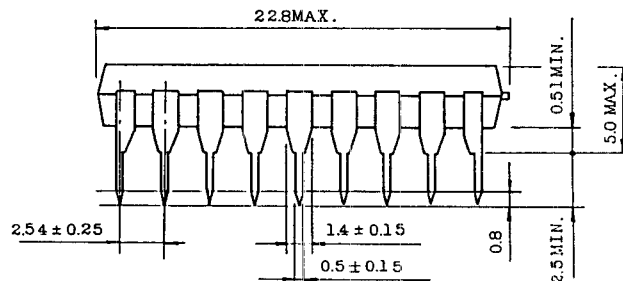
Fig. 2 Test Mode Cycle

OUTLINE DRAWINGS

- Plastic DIP



Unit: in mm

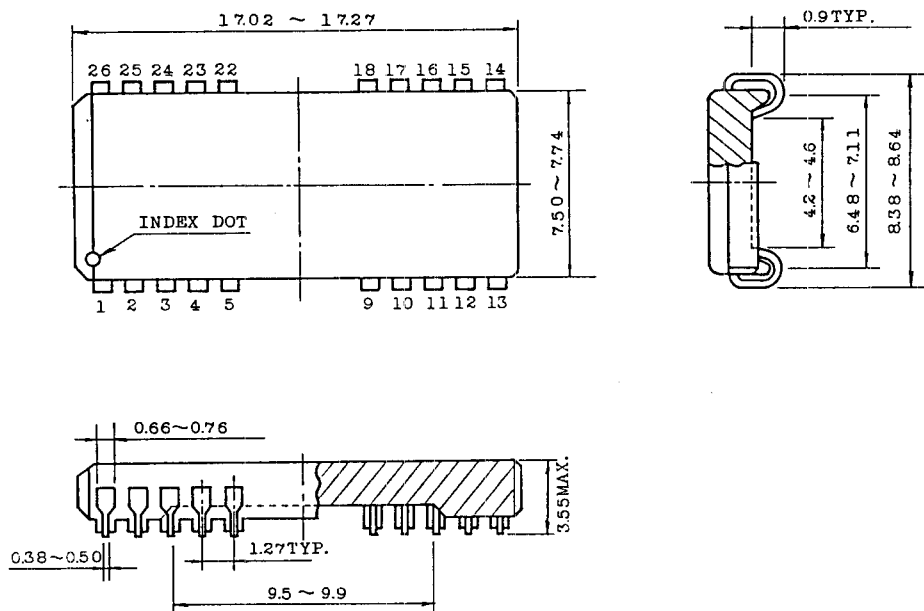


Note: Each lead pitch is 2.54mm.
All leads are located within 0.25mm of their true longitudinal position with respect to No. 1 and No. 18 leads.
All dimensions are in millimeters.

TC511000P/J/Z-85, TC511000P/J/Z-10 TC511000P/J/Z-12

● Plastic SOJ

Unit in mm



Note: Each lead pitch is 1.27mm.
All dimensions are in millimeters.